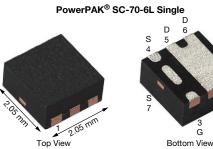
SiA447DJ Vishay Siliconix

www.vishay.com

P-Channel 12 V (D-S) MOSFET





Marking code: BR

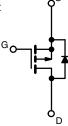
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-12				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -4.5 V	0.0135				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -2.5 V	0.0194				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -1.8 V	0.0344				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_GS$ = -1.5 V	0.0710				
Q <sub>g</sub> typ. (nC)	31				
I <sub>D</sub> (A) <sup>a</sup>	-12				
Configuration	Single				

#### **FEATURES**

- TrenchFET<sup>®</sup> power MOSFET
- Thermally enhanced PowerPAK<sup>®</sup> SC-70 package - Small footprint area - Low on-resistance
- 100 % R<sub>a</sub> tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Providing low voltage drop in smart phones, tablet PCs, mobile computing: - Battery switches
  - Battery management
  - Load switches



P-Channel MOSFET

## ORDERING INFORMATION

Package	PowerPAK SC-70	
Lood (Ph) free and helegen free	SiA447DJ-T4-GE3	
Lead (Pb)-free and halogen-free	SiA447DJ-T1-GE3	

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)						
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage		V <sub>DS</sub>	-12	V		
Gate-source voltage		V <sub>GS</sub>	± 8	v		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-12 <sup>a</sup>			
	T <sub>C</sub> = 70 °C		-12 <sup>a</sup>			
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-12 <sup>a, b, c</sup>			
	T <sub>A</sub> = 70 °C		-10 <sup>b, c</sup>	A		
Pulsed drain current (t = 300 μs)	I <sub>DM</sub>	-50				
Continuous source-drain diode current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	-12 <sup>a</sup>			
Continuous source-drain diode current	T <sub>A</sub> = 25 °C		-2.9 <sup>b, c</sup>			
Maximum power dissipation	T <sub>C</sub> = 25 °C		19			
	T <sub>C</sub> = 70 °C	D	12	w		
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.5 <sup>b, c</sup>	vv		
	T <sub>A</sub> = 70 °C		2.2 <sup>b, c</sup>			
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Soldering recommendations (peak temperature)		260				

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, f	t ≤ 5 s	R <sub>thJA</sub>	28	36	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	5.3	6.5	0/10	

Notes

a. Package limited

b. Surface mounted on 1" x 1" FR4 board

t = 5 s C.

See solder profile (www.vishay.com/doc?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection d.

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components e.

f. Maximum under steady state conditions is 80 °C/W

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COMPLIANT

HALOGEN

FREE

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SiA447DJ

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = -250 \ \mu A$	-12	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	-7	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	3	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-0.4	-	-0.85	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = ± 8 V	-	-	± 100	nA	
Zara gata valtaga drain aurrant		$V_{DS} = -12 V, V_{GS} = 0 V$			-1		
Zero gate voltage drain current	IDSS	$V_{DS}$ = -12 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C	-	-	-10	μA	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \leq$ -5 V, $V_{GS}$ = -4.5 V	-10	-	-	А	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -7 \text{ A}$	-	0.0110	0.0135		
Drain-source on-state resistance <sup>a</sup>	Б	$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -5 \text{ A}$	-	0.0150	0.0194	Ω	
Drain-source on-state resistance "	R <sub>DS(on)</sub>	$V_{GS} = -1.8 \text{ V}, I_D = -3 \text{ A}$	-	0.0230	0.0344	52	
		$V_{GS} = -1.5 \text{ V}, \text{ I}_{D} = -1 \text{ A}$	-	0.0400	0.0710	1	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -6 V, I_D = -7 A$	-	35	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	2880	-	pF pF	
Output capacitance	C <sub>oss</sub>	$V_{DS}$ = -6 V, $V_{GS}$ = 0 V, f = 1 MHz	-	590	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	585	-		
Total gata abarga	0	$V_{DS} = -6 V, V_{GS} = -8 V, I_D = -13 A$	-	52	80		
Total gate charge	Qg	<sup>2</sup> g	-	31	47	nC	
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = -6 V, $V_{GS}$ = -4.5 V, $I_D$ = -13 A	-	4.2	-		
Gate-drain charge	Q <sub>gd</sub>		-	7.8	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz	0.8	4.3	8.6	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	30	60		
Rise time	tr	$V_{DD}$ = -6 V, $R_L$ = 0.6 $\Omega$	-	30	60	1	
Turn-off delay time	t <sub>d(off)</sub>	$I_D\cong$ -10 A, $V_{GEN}$ = -4.5 V, $R_g$ = 1 $\Omega$	-	60	120		
Fall time	t <sub>f</sub>		-	25	50		
Turn-on delay time	t <sub>d(on)</sub>		-	12	25	ns	
Rise time	t <sub>r</sub>	$V_{DD}$ = -6 V, $R_L$ = 0.6 $\Omega$	-	10	20		
Turn-off delay time	t <sub>d(off)</sub>	$I_D\cong$ -10 A, $V_{GEN}$ = -8 V, $R_g$ = 1 $\Omega$	-	65	130		
Fall time	t <sub>f</sub>		-	20	40		
Drain-Source Body Diode Characterist	ics						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-12		
Pulse diode forward current	I <sub>SM</sub>				-50	A	
Body diode voltage	V <sub>SD</sub>	$I_{\rm S}$ = -10 A, $V_{\rm GS}$ = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	25	50	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = -10 A, di/dt = 100 A/μs,	-	7.5	15	nC	
Reverse recovery fall time $t_a$ $T_J = 25 °C$			-	8	-		
Reverse recovery rise time	t <sub>b</sub>		-	17	-	ns	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2%

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability

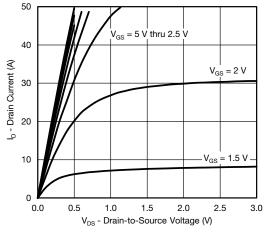
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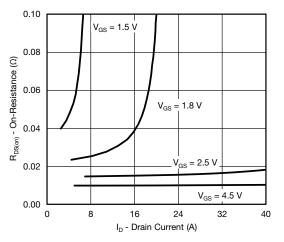
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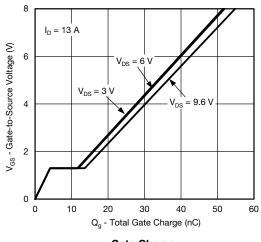
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



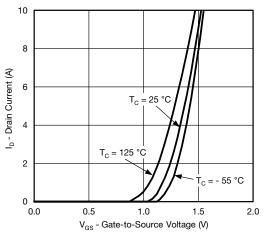
**Output Characteristics** 



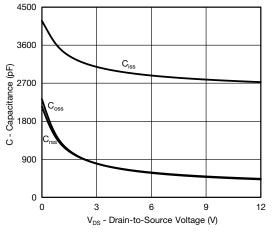
**On-Resistance vs. Drain Current and Gate Voltage** 



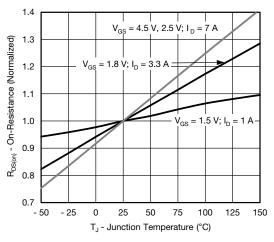
Gate Charge



Transfer Characteristics



Capacitance



**On-Resistance vs. Junction Temperature** 

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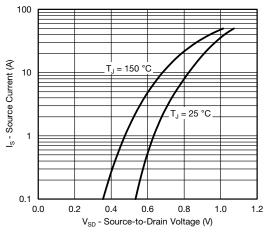
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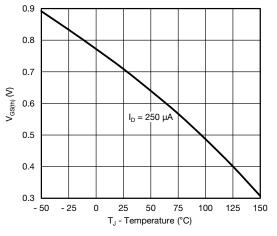
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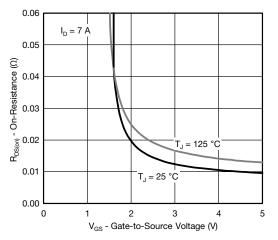
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



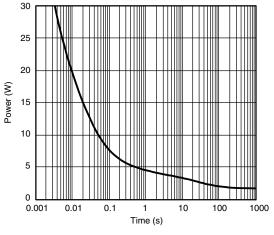
Source-Drain Diode Forward Voltage



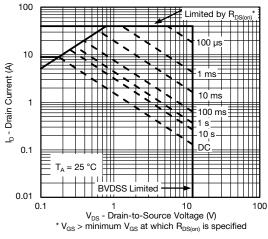




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

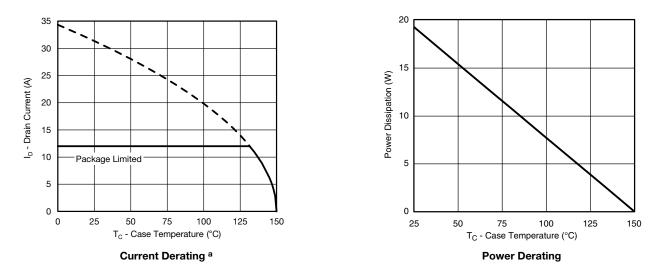


Safe Operating Area, Junction-to-Ambient

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

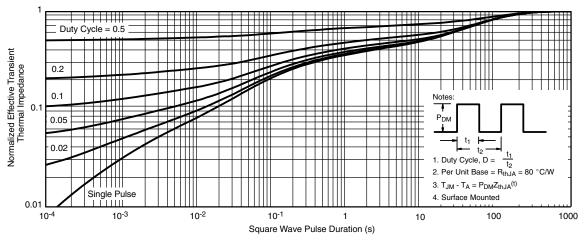


#### Note

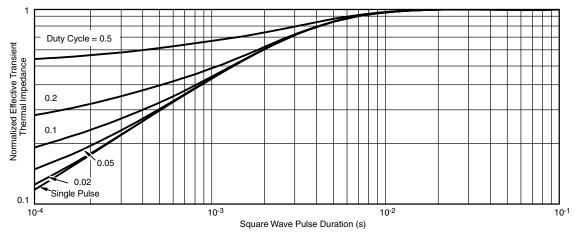
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



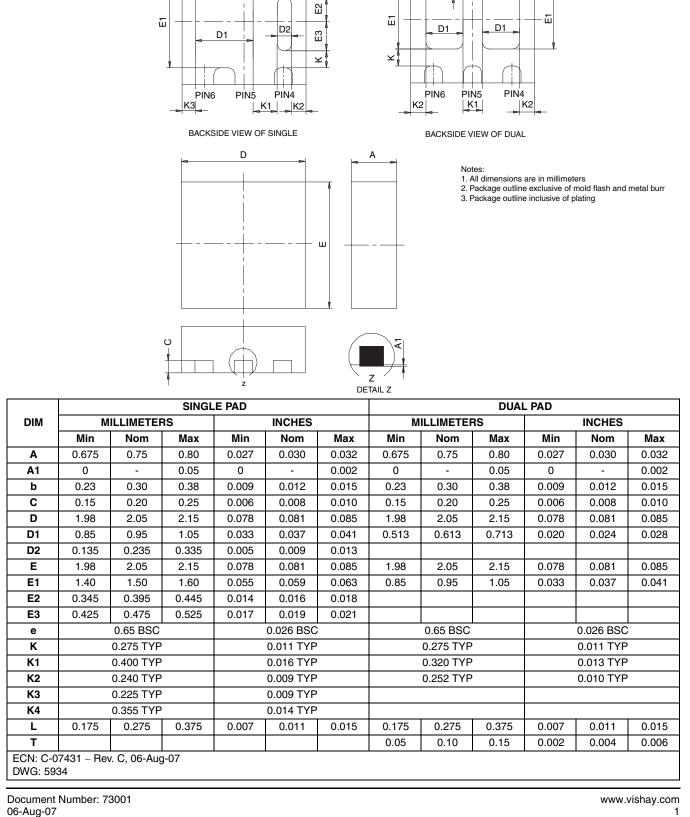
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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b

PIN3

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PIN2

PIN1

# **Package Information**

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PIN3

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PIN2

PIN1

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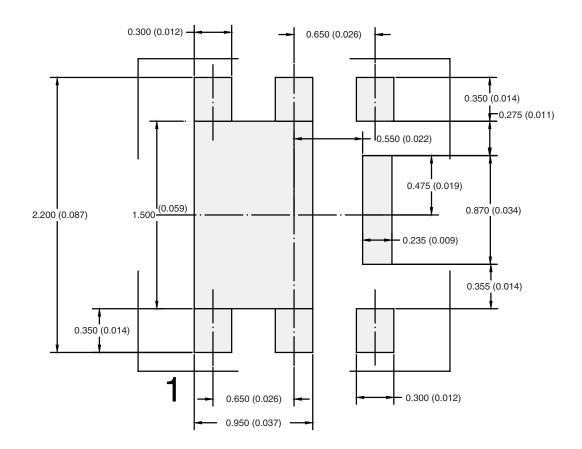
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VISHA

PowerPAK<sup>®</sup> SC70-6L



## RECOMMENDED PAD LAYOUT FOR PowerPAK<sup>®</sup> SC70-6L Single



Dimensions in mm/(Inches)

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APPLICATION NOTE



Vishay

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